

PATENTFor: ☐ U.S. and/or ☐ Foreign RightsFor: ☐ U.S. Application or ☐ U.S. PatentBy: ☐ Inventor(s) or ☐ Present Owner**ASSIGNMENT OF INVENTION**

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration,

ASSIGNOR:

(inventor(s) or

Seong Eun, Lee

(Type or print name(s) of ASSIGNOR(S))

person(s) or entity(ies)
who own the invention)

102-507, Godam Dormitory, san 11, Godam-ri,

Address

Taewol-myon, Ich'on, Kyoungki-do, KoreaRepublic of Korea

Nationality

(If assignment is by person or entity to whom invention was previously assigned and this was recorded in PTO add the following)

Recorded on _____

Reel _____

Frame _____

hereby sells, assigns and transfers to

ASSIGNEE:

Hyundai Electronics Industries Co., Ltd.

(Type or print name of ASSIGNEE)

San 136-1, Ami-ri, Bubal-eub, Ich'on, Kyoungki-do,

Address

KoreaRepublic of Korea

Nationality

and the successors, assigns and legal representatives of the ASSIGNEE

(complete one of the following)☒ the entire right, title and interest☐ an undivided _____ percent (_____%) interest

for the United States and its territorial possessions

(check the following box if foreign rights are also to be assigned)☐ and in all foreign countries, including all rights to claim priority,

in and to any and all improvements which are disclosed in the invention entitled:

METHOD OF MANUFACTURING SEMICONDUCTOR DEVICE**PATENT****REEL: 9676 FRAME: 0463**

(check and complete (a), (b), (c) or (d))

and which is found in

- (a) ☒ U.S. patent application executed on even date herewith
- (b) ☐ U.S. patent application executed on _____
- ☐ To comply with CFR 3.21 for recordal of this assignment, I, an ASSIGNOR signing below, hereby authorize and request my attorney, as named in the Declaration and Power of Attorney I executed for this invention on the execution date stated above, to insert below the filing date and application number when it becomes known.
- (c) ☐ U.S. application serial no. 0 / _____ filed on _____
- (d) ☐ U.S. patent no. _____ issued _____
- ☐ A change of address to which correspondence is to be sent regarding patent maintenance fees is being sent separately.

(also check (e) if foreign application(s) is also being assigned)

- (e) ☐ and any legal equivalent thereof in a foreign country, including the right to claim priority

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the purposes thereof.

IN WITNESS WHEREOF, I/We have hereunto set hand and seal this
December 18, 1998 (Date of signing).

WARNING: Date of signing must be the same as the date of execution of the application if item (a) was checked above.

Seong Eun, Lee

S.E. Lee

Signature of ASSIGNOR(S)

If ASSIGNOR is a legal entity complete the following information

Type or print the name of the above person
authorized to sign on behalf of ASSIGNOR

Title